## RFQ - BS-V1

## Fab

• Part number: **BS-V1** 

• Dimensions: 26mm x 26mm

Layers: 4Arrays: No

Surface Finish: ENIG

Material: FR4Solder Mask

o Sides: Both

Color: Matte Black

• Silk Screen

Sides: BothColor: White

• Controlled Dielectric: No

• Controlled Impedance: Yes

o Layer 1 and 4

50Ω ± 10% Single-Ended
 90Ω ± 10% Differential

• Finished Thickness: 0.8mm

Inner Copper: 1oz
Outer Copper: 1oz
Board Type: Rigid
Stackup: Standard
Number of Holes: 137

Minimum Hole Size: 0.152mmMinimum Trace: 0.178mm

Minimum Spacing: 0.127mmBlind/Buried Vias: No

Via-In-Pad: NoTinted Vias: Yes

• Drill Features (countersinks/counterbores): No

• Slot Features (beveled slots, castellated/controlled depth): Yes

• IPC Class: IPC 6012 Class 2

ITAR: No

## **Assembly**

Part number: BS-V1-ASSY

RoHS: Yes

• Number of Sides for Assembly: 2 Sides

ITAR: No

• Assembly Specification: IPC-A-610 Class 2

• Clean/No-Clean: Clean

• Type of Assembly: Full Turnkey